# PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

## **CONVEYING PARTY DATA**

Name	Execution Date
Yeh-Hsin Yu	09/20/2007
Jian-Hung Chen	09/20/2007
Chia Ho Chuang	09/20/2007
Hsueh Cheng Wu	09/20/2007

## **RECEIVING PARTY DATA**

Name:	TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD.	
Street Address:	No. 6, Li Hsin Rd. VI, Science-Based Industrial Park	
City:	Hsinchu	
State/Country:	y: TAIWAN	
Postal Code:	300	

## PROPERTY NUMBERS Total: 1

Property Type	Number	
Application Number:	11864469	

## **CORRESPONDENCE DATA**

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NAME OF CURNITTED.	Anthony ICon
ATTORNEY DOCKET NUMBER:	18506-095

NAME OF SUBMITTER: Anthony King

Total Attachments: 2

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PATENT REEL: 020104 FRAME: 0306 US0183

Signature of Witness (optional)

ASSIGNMENT

US ONLY

WHEREAS, I(we), YU,YEH-HSIN, CHEN,JIAN-HUNG, CHUANG CHIA HO, WU,HSUEH CHENG

whose post office address(es) appear(s) below, hereinafter referred to as ASSIGNOR, have invented certain new and useful invention entitled APPARATUS AND METHOD FOR SEMICONDUCTOR WAFER TRANSFER (hereinafter referred to as the INVENTION) for which an application for United States Letters Patent /Utility Patent is executed on even date herewith unless at least one of the following is checked: United States Design Patent was are executed on: Serial No.: 11/864,469 ☑ filed on: September 28 2007 a established by PCT International Patent Application No.: filed: designating the United States of America ☐ issued on as U.S. Patent No.: WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. whose post office address is NO. 6, LI HSIN RD. VI, SCIENCE-BASED INDUSTRIAL PARK, HSINCHU 300, TAIWAN, R.O.C. hereinafter referred to as ASSIGNEE, is desirous of acquiring the entire right, title and interest in and to the same in the United States and its territorial possessions; NOW, THEREFORE, for good and valuable consideration, receipt of which is hereby acknowledged, I (we), ASSIGNOR, by these presents do sell, assign and transfer unto said Assignee, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all Letters Patent granted on any division, continuation, continuation-in-part and reissue of said application for the full term or terms for which the same may be granted, including all priority rights under any International Convention. ASSIGNOR further covenants that no assignments, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this Assignment; ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent application(s) in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the Invention that are within Assignor's possession or control, and to provide further assurances and testimony on behalf of Assignee that lawfully may be required of Assignor in respect of the prosecution, maintenance, litigation and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to Assignor's heirs, executors, administrators and other legal representatives. ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all Letters Patent referred to above to Assignee, as the Assignee of the entire right, title and interest in and to the same, for Assignee's sole use and behoof; and for the use and behoof of ASSIGNEE'S legal representatives and successors, to the full end of the term for which such Letters Patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made. ASSIGNOR authorizes any member of the firm of \_\_WPAT, PC (Customer No. 60951) to insert or complete any information in this document needed to effect its recordal in the U.S. Patent and Trademark Office. Assignor Name NO.229, GUANGFU E. RD., HUKOU TOWNSHIP, HSINCHU YU, YEH-HSIN COUNTY 303, TAIWAN, R.O.C. Signature of Assignor Date of Signature Yy, Yek-lisin 9/20/2007 Name of Witness (optional) Name of Witness (optional)

Signature of Witness (Optional)

PATENT REEL: 020104 FRAME: 0307

Äddress
NO.9, LANE 264, ZHONGZHENG RD., SHULIN CITY, TAIPEI COUNTY 238, TAIWAN 300, R.O.C.
Date of Signature
9/20/2007
Name of Witness (optional)
Signature of Witness (Optional)

Assignor Name	Address
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Signature of Assignor	Date of Signature
CHUANG CHIA HO	9/20/2007
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

Assignor Name	Address
wu,hsueh cheng Win, Haleh Cheng	NO.13-13, FUCYUN ST., SIANGSHAN DISTRICT, HSINCHU CITY 300, TAIWAN ,R.O.C.
Signature of Assignor	Date of Signature 9/20/2007
Name of Witness (optional)	Name of Witness (optional)
Signature of Witness (optional)	Signature of Witness (Optional)

PATENT REEL: 020104 FRAME: 0308

**RECORDED: 11/13/2007**